



India's Transformation into Emerging Tech, Industry 4.0 & Mobile Manufacturing Hub

New Delhi
2 August 2022
Hotel Le Meridien



Program Schedule



Time	Sessions
9:30 AM	Registration & Networking Tea
10:00 AM - 4:00 PM (Separate Hall)	Skill Challenge Competition – Hand Soldering/Wire Harness/PCB Design B2B with International Delegates
Inaugural Session	
10:30 AM	Welcome Address by Mr Virat Bhatia, Chairman, ICT, Digital Economy & Mobile Manufacturing Committee, FICCI
10:40 AM	Special Address on “Electronics Manufacturing Embraces Digital” by Dr. John W. Mitchell, Chief Executive Officer, IPC
11:00 AM	Chief Guest Address By – Mr. Rajeev Chandrasekhar, Honourable Minister of State, Ministry of Skill Development and Entrepreneurship; and Ministry of Electronics and Information Technology, Government of India (TBC)
11:25 AM	Vote of Thanks by FICCI
Panel Discussion	
11:30 AM	<p>“India’s Transformation into Emerging Tech, Industry 4.0, and Mobile Manufacturing Hub – Opportunities, Challenges & Way Forward”</p> <p>Session Moderator: FICCI</p> <p>Panel Members:</p> <ul style="list-style-type: none"> Ministry of Electronics & IT, Govt of India CEO, Manufacturers Association of Information Technology (MAIT) President, Electronic Industries Association of India (ELCINA) President, Indian Printed Circuit Association (IPCA) Chairman, Electronics & Software Export Promotion Council (ESC India) Singapore Government (TBC) <p>Q&A Session</p>
1:00 PM - 2:30 PM	Networking Lunch
Technical Session on Industry 4.0	
2:30 PM	Welcome Address & Brief on “How Smart Manufacturing & Industry 4.0 shaping up in India” by Mr. Anup Wadhwa, Director, Automation Industry Association
2:50 PM	Presentation on “Factory of the Future” - David Bergman, Vice President (Standards & International Relations) IPC
3:20 PM	Presentation by Mr Sunil Mehta, President, Automation Industry Association & General Manager, Mitsubishi Electric India Pvt. Ltd.
3:50 PM	Presentation by Indian Institute of Technology (TBC)
4:15 PM	Q&A Session
4:30 PM	High Tea & End of Program

Supported by



Exhibitors :-

Name of the Company	Product/Services to be displayed	Website
HTL Ltd.	Optical Fiber Cables/ OFC Component/ Passive Connectivity Solutions/ Electrical Wiring Interconnect Solutions	https://www.htlchennai.com/
Hakko Japan/Sumitron	Soldering/De-soldering/Rework solutions	https://hakkousa.com/
Mectronics	Heraeus (SMT Materials), Zestron (Cleaning Chemicals), Humiseal (Conformal Coatings), Metcal (Bench Top Advanced Manufacturing Tools), KIC (Thermal profiling)	https://www.mectronics.in/
UNIX Japan	Soldering Automation	https://www.japanunix.com/en/
Electronics For You	Electronics & Technology digital & print publication	https://www.electronicsforu.com/

